Business Overview
Years ended March 31

■ Breakdown of Net Sales

<table>
<thead>
<tr>
<th></th>
<th>2004</th>
<th>2005</th>
<th>2006</th>
</tr>
</thead>
<tbody>
<tr>
<td>Technology Solutions</td>
<td>2,928</td>
<td>2,934</td>
<td>2,983</td>
</tr>
<tr>
<td>Ubiquitous Product Solutions</td>
<td>948</td>
<td>1,031</td>
<td>1,059</td>
</tr>
<tr>
<td>Device Solutions</td>
<td>804</td>
<td>794</td>
<td>707</td>
</tr>
</tbody>
</table>

■ Net Sales* (Billions of Yen)

* Including intersegment sales

■ Operating Income (Billions of Yen)

2004 2005 2006
Technology Solutions 139 142 164
Ubiquitous Product Solutions 31 31 34
Device Solutions 27 32 33
Underpinned by a range of highly reliable, high-performance IT system platforms employing cutting-edge technologies, we provide best-fit services for individual client operations and solutions that span the entire IT system lifecycle.

Main Products & Services
System Platforms: Full range of servers (mainframe, UNIX, mission-critical IA, PC), storage systems, various types of software (operating system, middleware), optical transmission systems, and mobile phone base stations
Services: Consulting, systems integration, outsourcing services, network services, system support services, information system installation and network construction, and dedicated terminal systems and equipment (ATMs, POS systems)

Emphasizing speed-to-market and price-competitiveness through highly efficient manufacturing activities, our PCs, mobile phones, and hard disk drives are vital to the realization of a ubiquitous networked world.

Main Products & Services
PCs, mobile phones, storage equipment (hard disk drives, magneto-optical disk drives), optical transmitter and receiver modules and other products

Logic LSI chips and related electronic components are core technologies that we provide to customers inside and outside the Group as part of highly optimized solutions that help to enhance the competitiveness of their products.

Main Products & Services
Logic LSI devices (system LSI, ASICs, microcontrollers, FRAM*1–embedded logic), system memory devices (flash memory, FCRAM*2), semiconductor packages, SAW*3 devices, and other electronic components

*1 Ferroelectric random access memory: A nonvolatile memory characterized by low power consumption, fast write times and numerous read-write cycles. (FRAM is a trademark of Ramtron International Corporation.)

*2 Fast-cycle random access memory: High-speed DRAM that incorporates our original pipeline operation technology to accelerate memory read-write cycles.

*3 SAW devices boost the performance of mobile phones and other mobile devices and also help to reduce size and power consumption.